Electronic Materials and Photonics
Room 207 A W - Session EM1+AP+CPS+MS+PS+QS+SM+TF-TuM

Emerging Frontiers in Quantum Materials and Devices
Moderator: Mollie Schwartz, MIT Lincoln Laboratory

8:30am **EM1+AP+CPS+MS+PS+QS+SM+TF-TuM-3 Rapid, Atomic-Scale Smoothing of GaSb(111)A Surfaces During Molecular Beam Epitaxy***, **James Rushing**, Paul Simmonds,* Tufts University

InAs/Ga(In)Sb quantum wells (QWs) with a broken gap band alignment can behave as a quantum spin hall insulator (QSHI) with an insulating bulk and topologically protected helical edge states [1-2]. QSHIs could be a key component in spintronic and topological quantum computing applications [2-3]. Producing a topological phase transition in InAs/Ga(In)Sb QWs requires precise control of QW thickness, composition and quality, particularly at the heterointerfaces. Additionally, our calculations suggest QWs grown on (111) surfaces could provide benefits over (001) due to the higher symmetry and out-of-plane polarization effects of this surface.

While exploring the MBE growth of InAs/Ga(In)Sb QW heterostructures on GaSb(111)A, we discovered an exciting and confounding phenomenon that seems to be unique to crystal growth on III-Sb(111)A surfaces. Ga(In)Sb(111)A frequently exhibits an extremely rough morphology characterized by pyramidal peaks covering the entire surface. We show that rough III-Sb surfaces (pyramidal features >70nm in height; rms roughness >10nm), can be smoothed to atomically flat surfaces (<3nm height features; <0.5nm rms roughness) in a matter of seconds by exposing them to an arsenic over-pressure. We first observed this phenomenon when rough GaInSb(111)A surfaces became atomically flat after capping with just 8nm of InAs. After reducing the thickness of this InAs layer to a single monolayer and still observing he same surface smoothing effect, we found that we could achieve almost identical results by simply exposing the rough GaSb(111)A to an arsenic flux. These results suggest that arsenic is the primary mover in these profound morphological changes. Our recent results show that the smoothing can be accomplished with As_4 or As_2, and with a wide range of arsenic beam equivalent pressures, from $5x10^{-7}$ to $1x10^{-5}$ Torr.

We will describe our efforts to gain control and understanding of this phenomenon through the modulation of arsenic exposure time, flux, and terminating III-Sb material. This powerful new MBE technique will allow us to reliably achieve smooth heterointerfaces in (111)-oriented InAs/Ga(In)Sb QWs for novel, high-quality QSHIs. More broadly, we believe that this approach will enable the growth of a wide array of III-Sb-based nanostructures on (111)A surfaces for other electronic and photonic applications.

1. Krishtopenko and Teppe. *Science Advances* **4**, eaap7529 (2018)
2. Avogadri et al. *Physical Review Research* **4**, L042042 (2022)
3. Du et al. *Physical Review Letters* **119**, 056803 (2017)

8:45am **EM1+AP+CPS+MS+PS+QS+SM+TF-TuM-4 Benchmarking Different NbTiN Sputtering Methods for 300 mm CMOS-compatible Superconducting Digital Circuits**, *Adham Elshaer*[1], ***Jean-Philippe Soulié**, Daniel Perez Lozano, Gilles Delie, Ankit Pokhrel, Benjamin Huet,* IMEC Belgium*; Margriet J. Van Bael,* KU Leuven and Imec, Belgium*; Daan Buseyne,* KU Leuven, Belgium*; Blake Hodges, Seifallah Ibrahim, Sabine O'Neal,* Imec USA*; Zsolt Tökei,* Imec Belgium*; Anna Herr, Quentin Herr,* Imec USA

The NbTiN films presented here are CMOS-compatible and were developed for metallization purposes in superconducting digital circuits [1-5]. Those circuits use NbTiN for Josephson junctions and capacitors electrodes, as well as for wiring. Superconducting digital circuits initially relied on Nb in the early days. NbTiN is a better candidate/replacement due to its higher thermal budget and better chemical stability [1-5]. In this study, the properties of superconducting NbTiN thin films deposited using two different sputtering methods have been compared. One method used multiple targets (MT) co-sputtering (Nb and Ti targets), while the other used a NbTi single target (ST). Benchmarking metrics used for comparison include: superconducting, electrical, as well as morphological properties. All films show a high Tc, ranging from 13.3 K to 15.1 K. Compared to MT, ST NbTiN films showed consistently lower resistivity and better sheet resistance (Rs) wafer-level uniformity (49 points wafer-map). For instance, 50 nm MT film had a Rs relative standard deviation (Stddev%) of 15.5%, while for the ST NbTiN films, Rs Stddev% showed a 2-fold improvement at 7.8%. Upon annealing of the ST NbTiN films at 650℃, the Rs uniformity further improved, reflected by a lower Stddev% at 4.5%. AFM data show similar results for MT and ST films, ~1.07 nm and 1.09 in the center and 0.73 nm and 0.71 nm at the edge of the wafers, respectively. Furthermore, XRD theta-2theta scans have been performed showing the 200 and 111 peaks for NbTiN orientations. Results show that the MT and ST films have different/signature 200/111 peak intensity ratios for the as deposited films. ST NbTiN films have a lower 200/111 peak ratio. However, after annealing at 650℃, the ST films 200/111 peak ratio increases, and surpasses that of the MT NbTiN films. This change suggests a change in the ST film disorder and grain size after annealing. The impact of the ST NbTiN film thickness on properties has also been studied. The Tc shows an increase as a function of thickness, from 9.6 K for 7 nm, to 14.3 K for 50 nm, up to 14.9 K for 200 nm films. Certainly, the ability to tune the superconducting properties of NbTiN, makes them appealing from a stack engineering perspective. Both MT and ST NbTiN properties can be tailored using deposition conditions such as: power, partial pressure and post deposition annealing [3]. However, MT NbTiN films 300 mm wafer-level Rs non-uniformity represents a limiting factor for scaling superconducting devices. Annealed NbTiN ST films on the other hand, show a 3.4-fold Rs wafer uniformity improvement while maintaining properties tunability.

9:00am **EM1+AP+CPS+MS+PS+QS+SM+TF-TuM-5 Controlling the Properties of Epitaxially Grown Topological Semimetals***, **Kirstin Alberi**,* National Renewable Energy Laboratory **INVITED**

Three dimensional topological semimetals (TSMs) exhibit a wide range of interesting properties, including high carrier mobility, large magnetoresistance, anomalous transport behavior, broadband optical absorption and non-linear optical responses. Epitaxial thin film synthesis offers a practical platform for manipulating composition, defects and disorder in these materials, offering a window into approaches for manipulating their properties. In this talk, I will discuss insights into the relationships between structure and composition and the resulting properties revealed through careful control of growth conditions. Focused examples include the impact of point defects and impurities on electron transport in the Dirac TSM Cd_3As_2 and the formation and behavior of domain boundaries in the Weyl TSM TaAs.

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9:30am **EM1+AP+CPS+MS+PS+QS+SM+TF-TuM-7 Photon Down-Conversion of Yb-Doped CsPb(Cl1-xBrx)3 to Low-bandgap Metal Halide Perovskites**, ***Yutong Ren***[2], Princeton University*; Igal Levine,* The Hebrew University of Jerusalem, Israel*; Dan Oron, David Cahen,* Weizmann Institute of Science, Israel*; Antoine Kahn,* Princeton University

Quantum cutting represents a transformative strategy to mitigate thermalization losses that typically occur when high-energy photons are absorbed by semiconductors.[1,2] Recent advances have extended this concept from rare-earth doped crystals to semiconductor–rare-earth hybrid systems, particularly those utilizing halide perovskite absorbers, thereby exploiting their exceptional optoelectronic properties.

In this study, we focus on Ytterbium (Yb) -doped $CsPb(Cl_{1-x}Br_x)_3$, a metal halide perovskite that absorbs visible light and exhibits intense near-infrared (NIR) photoluminescence—a clear signature of efficient quantum cutting. Upon excitation with visible light, the doped perovskite converts the absorbed energy into two NIR photons, with the emission energy closely matching the optimized bandgap of a Sn–Pb based perovskite absorber. This spectral alignment is critical for enabling effective energy transfer between the quantum cutting layer and the absorber.

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[1] **JVST Highlighted Talk**

[2] **JVST Highlighted Talk**

Our investigation focuses on elucidating the structural and electronic properties of the interfaces between Yb-doped $CsPb(Cl_{1-x}Br_x)_3$ and Sn–Pb based perovskite films. By employing a suite of advanced spectroscopic techniques—including ultraviolet photoelectron spectroscopy, inverse photoemission spectroscopy, time-resolved photoluminescence (tr-PL), and time-resolved surface photovoltage (tr-SPV)—we systematically examine how the quantum cutting layer, the absorber layer, and their interfacial region collectively influence energy transfer efficiency. In particular, the complementary tr-PL and tr-SPV analyses unambiguously determine the dominant interfacial charge transfer and recombination processes, and thus gain control over the interfacial charge transfer. By integrating Yb-doped $CsPb(Cl_{1-x}Br_x)_3$ with customized Sn–Pb perovskite absorbers, our approach shows promise for pushing the boundaries of conventional efficiency limits while also offering a cost-effective strategy for enhanced energy conversion.

1. Wegh, R. T. et al. Quantum cutting through downconversion in rare-earth compounds. *J. Lumin.* **87–89**, 1017–1019 (2000).

2. Kroupa, D. M. et al. Quantum-cutting ytterbium-doped $CsPb(Cl_{1-x}Br_x)_3$ perovskite thin films with photoluminescence quantum yields over 190%. *ACS Energy Lett.* **3**, 2390–2395 (2018).

9:45am **EM1+AP+CPS+MS+PS+QS+SM+TF-TuM-8 Molecular Beam Epitaxy Growth of $InAs_{1-x}Bi_x$ on GaSb for Topological Insulating States***, Merve* ***Baksi****, James Rushing, Xikae Xie, Avery Hanna, Larry Qui, Ekow Williams, Paul J. Simmonds,* Tufts University

Incorporation of bismuth (Bi) into III-V semiconductors has attracted significant interest not only for its ability to extend infrared optoelectronic applications across a wide spectral range but also for its potential to induce topologically protected surface states, which could form the foundation for certain quantum computing technologies [1].

Motivated by the small inverted band gap that can be induced in InAs/GaSb quantum wells (QWs) [2], we propose engineering the band structure and inducing the edge states through Bi incorporation into InAs layers. This enhancement is expected to improve robustness against thermal fluctuations, making the material viable for room temperature applications as opposed to the topological HgTe/CdTe QW system with a temperature dependent band gap [3].

Theoretical studies predict that $InAs_{1-x}Bi_x$ quantum wells exhibit a topological insulating state when the Bi composition reaches $x \approx 0.15$, with an estimated inverted gap of approximately 30 meV [1]. Given these predictions, InAsBi emerges as a promising candidate for realizing two-dimensional topological insulators (2D TIs). However, achieving such high Bi incorporation remains challenging due to the significant miscibility gap and the limited solubility of Bi in III-V materials [4].

In this work, we investigate the molecular beam epitaxy (MBE) growth of InAsBi on GaSb substrates, focusing on optimizing Bi incorporation and structural quality. By leveraging MBE growth techniques, we aim to systematically control Bi incorporation and assess its impact on electronic and structural properties of InAsBi in reduced dimensions. Our findings will contribute to the advancement of III-V-based topological materials and their potential integration into future quantum devices.

[1] Denis R. Candido, Michael E. Flatté, and J. Carlos Egues. Blurring the boundaries between topological and nontopological phenomena in dots. Phys. Rev. Lett., 121:256804, Dec 2018.

[2] S. Schmid, M. Meyer, F. Jabeen, G. Bastard, F. Hartmann, and S. Höfling. Exploring the phase diagram of InAs/GaSb/InAs trilayer quantum wells. Phys. Rev. B, 105:155304, Apr 2022

[3] M. Marcinkiewicz, S. Ruffenach, S. S. Krishtopenko, A. M. Kadykov, C. Consejo, D. B. But, W. Desrat, W. Knap, J. Torres, A. V. Ikonnikov, K. E. Spirin, S. V. Morozov, V. I. Gavrilenko, N. N. Mikhailov, S. A. Dvoretskii, and F. Teppe. Temperature-driven single-valley Dirac fermions in HgTe quantum wells. Phys. Rev. B, 96:035405, Jul 2017.

[4] K. Y. Ma, Z. M. Fang, R. M. Cohen, and G. B. Stringfellow. Organometallic vapor-phase epitaxy growth and characterization of Bi-containing III/V alloys. Journal of Applied Physics, 68(9):4586–4591, 11 1990.

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